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?	То	the Honorable Commissione. 101979677		the attached original documents or copy thereof.	
17.7	1	Name of conveying party(ies):	2	Name and address of receiving party(ies):	
		Clark Hu Hendrix Jeng Bor Ping Jang		Taiwan Semiconductor Manufacturing Co. Ltd. No. 121 Park Avenue 3 Science-Based Industrial Park Hsin-Chu, Taiwan, R.O.C.	
		Nature of conveyance: ■ Assignment		Hsin-Chu, Taiwan, R.O.C. Additional name(s) & address(es) attached □ Yes ☒ No	
		☐ Security Agreement ☐ Change of Name			
		☐ Other: Execution Date: December 12, 2001			
ľ	4	Application number(s) or patent number(s):	-		
		If this document is being filed together with a new application	, the	execution date of the application is:12-12-01	
		A. Patent Application No(s).		B. Patent No(s)	
	5	Additional numbers attained and address of party to whom correspondence concerning document should be mailed:	ache	d? □ Yes ⊠ No 10045412— Total number of applications and patents involved:	
		RANDY W. TUNG Tung & Associates	7	Total fee (37 CFR 3.41) \$40.00	
		838 W. Long Lake Road Suite 120	i	□ Enclosed	
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		Randy W. Tung Name of Person Signing Registration No. 31,311 Signature		January 12, 2002 Date	
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Mail documents to be recorded with required cover sheet information to: Commissioner of Patents & Trademarks, Box Assignments

Washington, D.C. 20231

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ASSIGNMENT

WHEREAS, we, CLARK HU, HENDRIX JENG and BOR PING JANG, have

invented certain improvements in

SEMICONDUCTOR WAFER TILT MONITORING ON

SEMICONDUCTOR FABRICATION EQUIPMENT PLATE

for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of

No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of

acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and

valuable consideration, the receipt of which is hereby acknowledged, we, CLARK HU, HENDRIX

JENG and BOR PING JANG, by these presents, do hereby sell, assign and transfer unto the said

corporation and its assigns, for the territory of the United States of America and all foreign countries,

the entire right, title and interest, including all priority rights under the International Convention

associated with each country of the Union, in and to said invention as described in the patent

application executed by us on the 12th and 13th day of December, 2001, preparatory to

obtaining Letters Patent of the United States thereon, and in and to said application and any Letters

Patent that may be granted in pursuance of said application and any divisional, continuation or

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continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

CLARK HU

HENDRIX JENG

To all

TUNG & ASSOCIATES 838 W. Long Lake Road Suite 120 Bloomfield Hills, Michigan 48302

RECORDED: 01/12/2002

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